


**N-Channel Enhancement-Mode
Vertical DMOS FETs**

T-35-25

Ordering Information

BV _{DSS} / BV _{PAS}	R _{DS(ON)} (max)	I _{D(ON)} (min)	Order Number / Package	
			TO-92	Dice [†]
40V	0.35Ω	8A	VN2204N3	VN2204ND
60V	0.35Ω	8A	VN2206N3	VN2206ND
100V	0.35Ω	8A	VN2210N3	VN2210ND

[†] MIL visual screening available
Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{ISS} and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

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Supertex Vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Applications

- Motor control
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

Package Options

(Note 1)



TO-92

Note 1: See Package Outline section for discrete pinouts.

Thermal Characteristics

T-35-25

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ $T_C = 25^\circ\text{C}$	θ_{ja} °C/W	θ_{jc} °C/W	I_{DR}^*	I_{DRM}
TO-92	1.2A	8.0A	1.0W	170	125	1.2A	8.0A

* I_D (continuous) is limited by max rated T_j .

Electrical Characteristics (@ 25°C unless otherwise specified)

(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	VN2204	40		V	$V_{GS} = 0, I_D = 10\text{mA}$
		VN2206	60			
		VN2210	100			
$V_{GS(th)}$	Gate Threshold Voltage	0.8		2.4	V	$V_{GS} = V_{DS}, I_D = 10\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-4.3	-5.5	mV/°C	$V_{GS} = V_{DS}, I_D = 10\text{mA}$
I_{GSS}	Gate Body Leakage		1	100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
I_{DSS}	Zero Gate Voltage Drain Current			50	μA	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
				10	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current	3	4.5		A	$V_{GS} = 5\text{V}, V_{DS} = 25\text{V}$
		8				$V_{GS} = 10\text{V}, V_{DS} = 25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		0.4	0.5	Ω	$V_{GS} = 5\text{V}, I_D = 1\text{A}$
			0.27	0.35		$V_{GS} = 10\text{V}, I_D = 4\text{A}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.85	1.2	%/°C	$V_{GS} = 10\text{V}, I_D = 4\text{A}$
G_F	Forward Transconductance	1.5	2.0		Ω	$V_{DS} = 25\text{V}, I_D = 2\text{A}$
C_{ISS}	Input Capacitance			500		
C_{OSS}	Common Source Output Capacitance			200	pF	$V_{GS} = 0, V_{DS} = 25\text{V}$
C_{RSS}	Reverse Transfer Capacitance			65		$f = 1 \text{ MHz}$
$t_{d(ON)}$	Turn-ON Delay Time		10	15	ns	$V_{DD} = 25\text{V}$ $I_D = 4\text{A}$ $R_S = 50\Omega$
t_r	Rise Time		10	15		
$t_{d(OFF)}$	Turn-OFF Delay Time		30	50		
t_f	Fall Time		30	50		
V_{SD}	Diode Forward Voltage Drop		1.0	1.6	V	$V_{GS} = 0, I_{SD} = 4\text{A}$
t_{rr}	Reverse Recovery Time		500		ns	$V_{GS} = 0, I_{SD} = 1\text{A}$

Notes:

1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300ms pulse, 2% duty cycle.)

2: All A.C. parameters sample tested.

Switching Waveforms and Test Circuit

